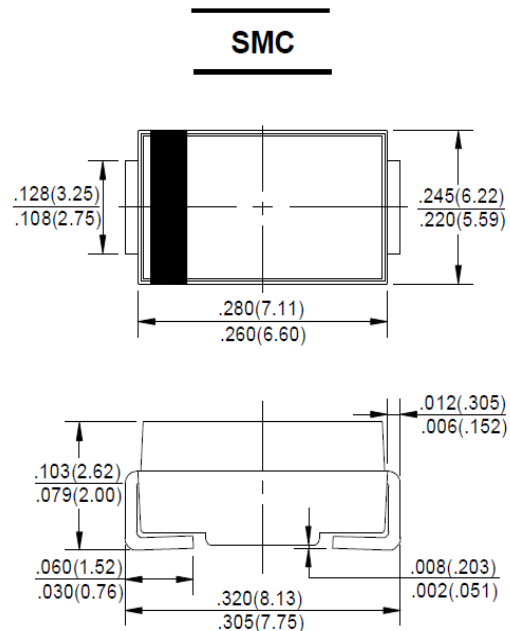


FEATURES

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- For surface mounted applications
- Low reverse leakage
- Built-in strain relief, ideal for automated placement
- High forward surge current capability
- High temperature soldering guaranteed: 250°C/10 seconds at terminals
- Glass passivated chip junction

MECHANICAL DATA

- **Case** : JEDEC DO-214AB molded plastic body
- **Terminals**: Solder plated, solderable per MIL-STD-750, Method 2026
- **Polarity** : Color band denotes cathode end
- **Mounting Position**: Any
- **Weight** : 0.007 ounce, 0.25 grams



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase. half wave. 60HZ. resistive or inductive load. For capacitive load. derate current by 20%

	SYMBOLS	S3A	S3B	S3D	S3G	S3J	S3K	S3M	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	VOLTS
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	VOLTS
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	VOLTS
Maximum average forward rectified current at $T_L=75^\circ\text{C}$	$I_{(AV)}$	3.0							Amps
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	100.0							Amps
Maximum instantaneous forward voltage at 3.0A	V_F	1.15							Volts
Maximum DC reverse current $T_A=25^\circ\text{C}$ at rated DC blocking voltage $T_A=100^\circ\text{C}$	I_R	10.0 100.0							μA
Typical junction capacitance (NOTE 1)	C_J	60.0							pF
Typical thermal resistance (NOTE 2)	$R_{\theta JA}$	47.0							$^\circ\text{C/W}$
Operating junction and storage temperature range	T_J, T_{STG}	-65 to +150							$^\circ\text{C}$

Note: 1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

2. P.C.B. mounted with 0.2x0.2" (5.0x5.0mm) copper pad areas

FIG. 1- FORWARD CURRENT DERATING CURVE

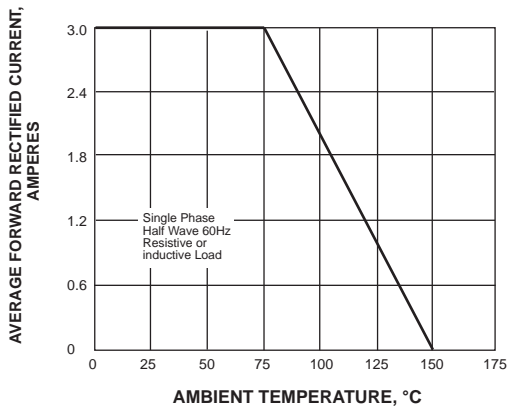


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

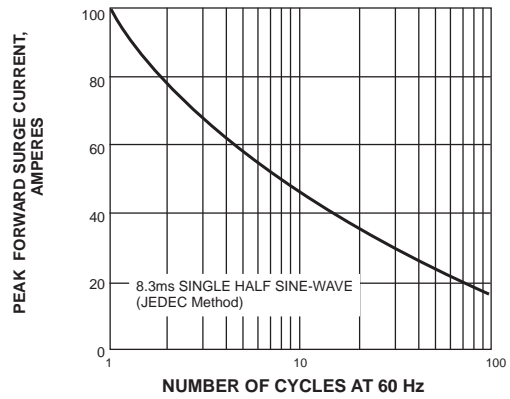


FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

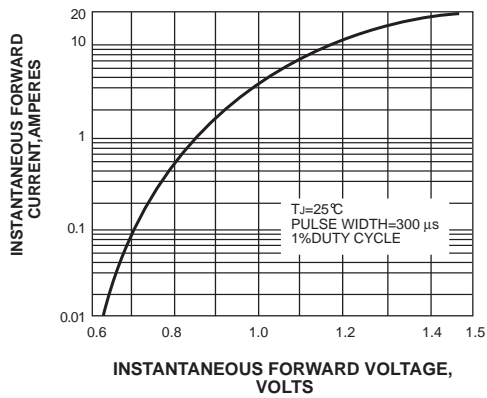


FIG. 4-TYPICAL REVERSE CHARACTERISTICS

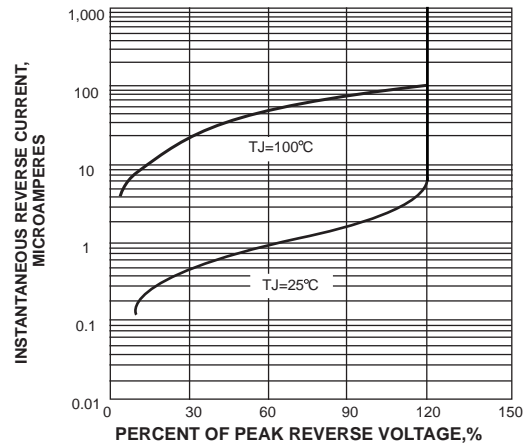


FIG. 5-TYPICAL JUNCTION CAPACITANCE

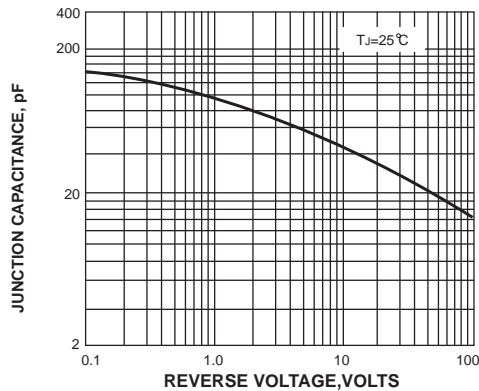
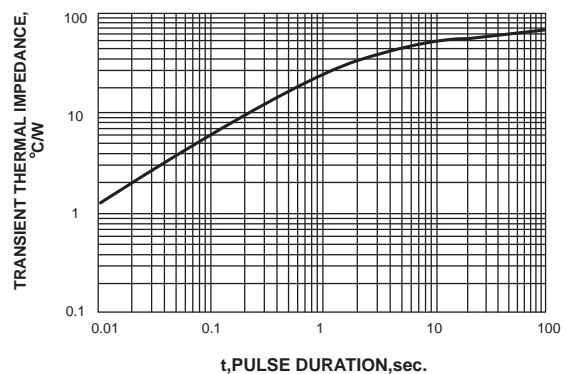


FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [Diodes - General Purpose, Power, Switching category:](#)

Click to view products by [Bourne manufacturer:](#)

Other Similar products are found below :

[MCL4151-TR3](#) [MMBD3004S-13-F](#) [RD0306T-H](#) [RD0506LS-SB-1H](#) [RGP30G-E373](#) [DSE010-TR-E](#) [BAQ333-TR](#) [BAQ335-TR](#) [BAQ33-GS18](#) [BAS1602VH6327XT](#) [BAV17-TR](#) [BAV19-TR](#) [BAV301-TR](#) [BAW27-TAP](#) [HSC285TRF-E](#) [NSVBAV23CLT1G](#) [NTE525](#) [1SS181-TP](#) [1SS184-TP](#) [1SS193,LF](#) [1SS193-TP](#) [1SS400CST2RA](#) [SBAV99LT3G](#) [SDAA13](#) [LL4448-GS18](#) [SHN2D02FUTW1T1G](#) [LS4150GS18](#) [LS4151GS08](#) [SMMD7000LT3G](#) [FC903-TR-E](#) [1N4449](#) [1N4934-E3/73](#) [1SS226-TP](#) [APT100DL60HJ](#) [RFUH20TB3S](#) [RGP30G-E354](#) [RGP30M-E3/73](#) [D291S45T](#) [MCL4151-TR](#) [BAS 16-02V H6327](#) [BAS 21U E6327](#) [BAS 28 E6327](#) [BAS33-TAP](#) [BAS 70-02V H6327](#) [BAV300-TR](#) [BAV303-TR3](#) [BAW27-TR](#) [BAW56DWQ-7-F](#) [BAW56M3T5G](#) [BAW75-TAP](#)